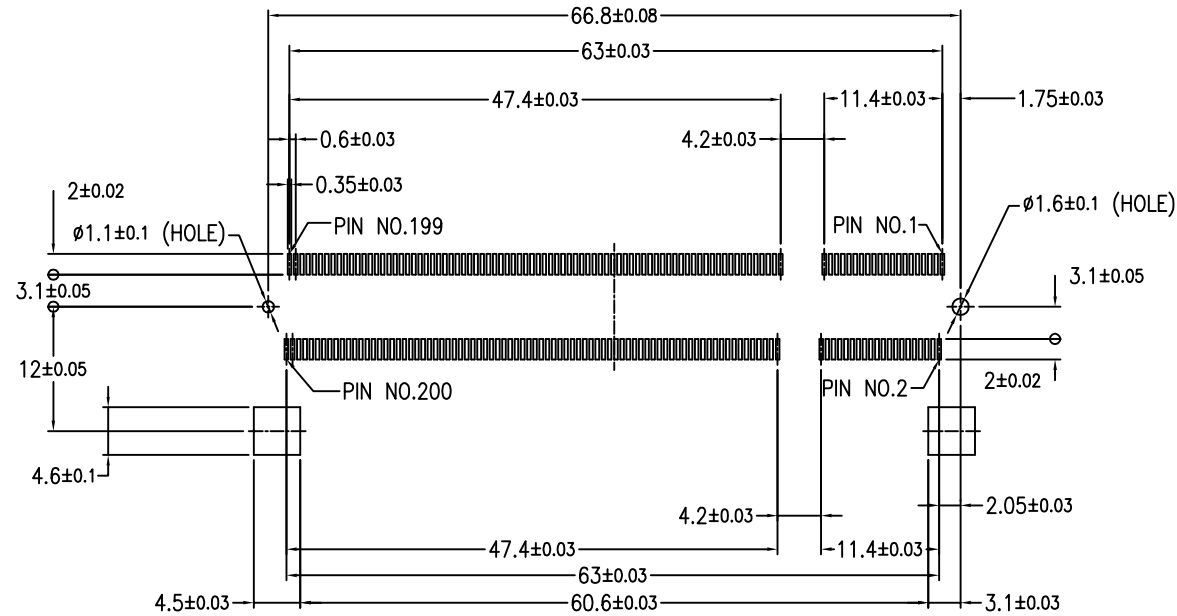


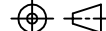


PRODUCT NO.

59354-x52xx

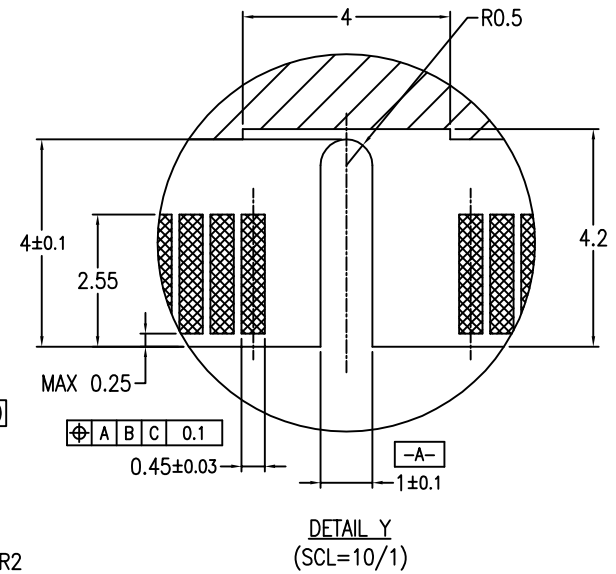
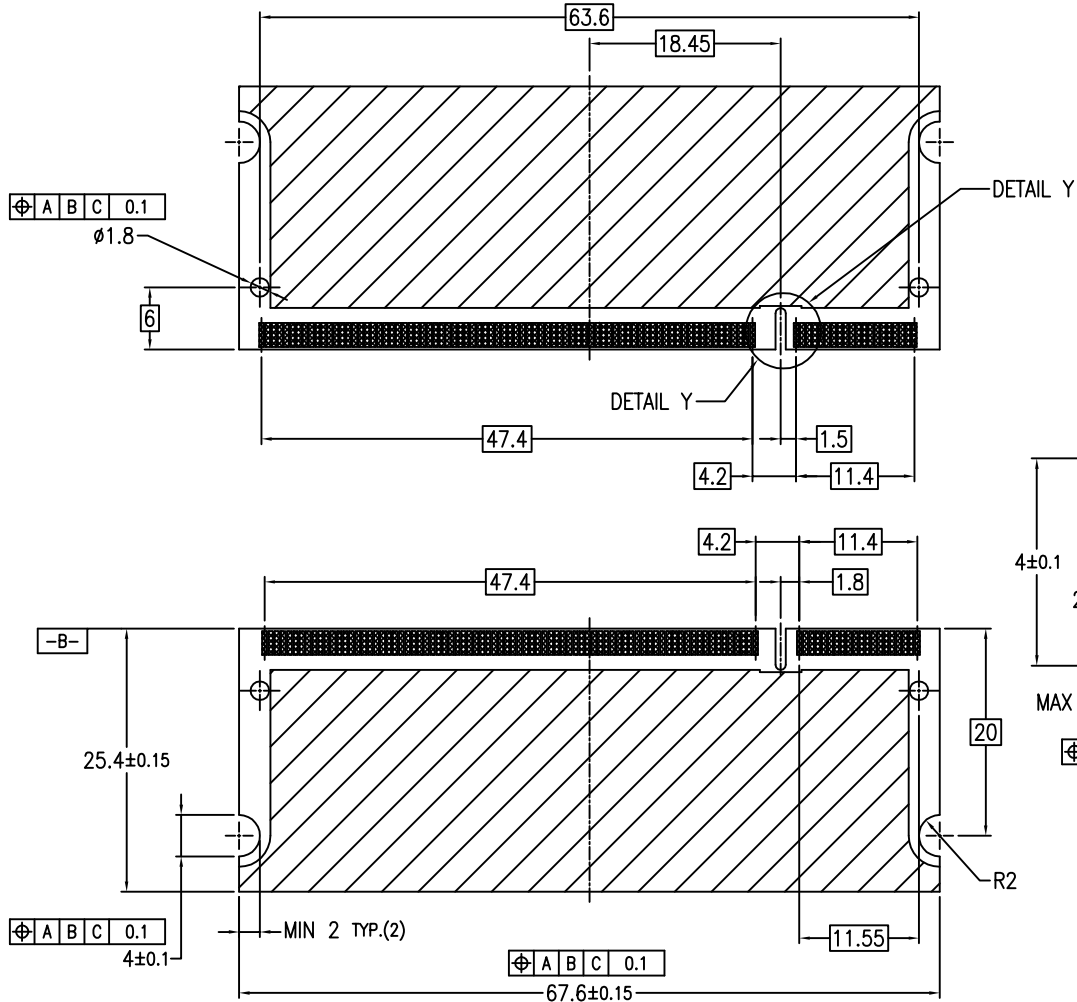
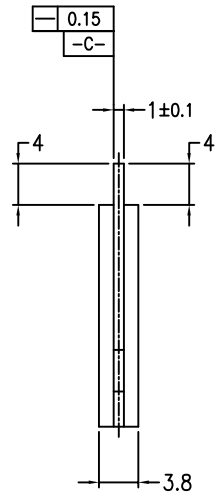


RECOMMENDED MOUNTING P.C.B LAYOUT

mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		 www.fciconnect.com											
ltr	ecn no	dr	date	linear	.X ± 0.30			projection 	title DDR SO-DIMM 0.6 mm PITCH 200 POS. STANDARD TYPE ASS'Y											
L					.XX ± 0.30															
				angles	0° ±2°			 scale 2:1	product family 50UF SO-DIMM						code JP					
				dr	M.Hasegawa	11/10/03	size dwg no						sheet 2 of							
				enrg	M.Hasegawa	11/10/03														
				chr																
				appd																
sheet index	revision sheet																			



PRODUCT NO.
59354-x52xx



RECOMMENDED MODULE P.C.B. LAYOUT

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	FCI		
ltr	ecn no	dr	date	linear	.X ± 0.30 .XX ± 0.30		www.fciconnect.com		
L				angles	0° ±2°	projection	title		
				dr	M.Hasegawa 11/10/03	MM	DDR SO-DIMM 0.6 mm PITCH 200 POS. STANDARD TYPE ASS'Y		
				enr	M.Hasegawa 11/10/03		product family 50UF SO-DIMM		code JP
				chr		scale	size dwg no		sheet
				appd			B 59354		3 of
sheet index	revision sheet								



PRODUCT NO.	LOCATING PEG	TERMINAL CONTACT AREA FINISH	HOLD DOWN FINISH	SOLDER TAIL FINISH
59354-052FS	YES	Au FLASH	Pure Sn PLATING	Au FLASH PLATING
59354-152FS	NO			
59354-052TS	YES	Au 0.3μm MIN.		
59354-152TS	NO			
59354-052AS	YES	Au 0.76μm MIN.		
59354-152AS	NO			
59354-052FC	YES	Au FLASH	Sn-Cu PLATING	
59354-152FC	NO			
59354-052TC	YES	Au 0.3μm MIN.		
59354-152TC	NO			
59354-052AC	YES	Au 0.76μm MIN.		
59354-152AC	NO			
59354-252FS	YES	Au FLASH	Pure Sn PLATING	Pure Sn PLATING
59354-352FS	NO			
59354-252TS	YES	Au 0.3μm MIN.		
59354-352TS	NO			
59354-252AS	YES	Au 0.76μm MIN.		
59354-352AS	NO			
59354-252FC	YES	Au FLASH	Sn-Cu PLATING	
59354-352FC	NO			
59354-252TC	YES	Au 0.3μm MIN.		
59354-352TC	NO			
59354-252AC	YES	Au 0.76μm MIN.		
59354-352AC	NO			

PRODUCT NO.	LOCATING PEG	TERMINAL CONTACT AREA FINISH	HOLD DOWN FINISH	SOLDER TAIL FINISH
59354-452FS	YES	Au FLASH	Pure Sn PLATING	Sn-Pb PLATING
59354-552FS	NO			
59354-452TS	YES	Au 0.3μm MIN.		
59354-552TS	NO			
59354-452AS	YES	Au 0.76μm MIN.		
59354-552AS	NO			
59354-452FC	YES	Au FLASH	Sn-Cu PLATING	
59354-552FC	NO			
59354-452TC	YES	Au 0.3μm MIN.		
59354-552TC	NO			
59354-452AC	YES	Au 0.76μm MIN.		
59354-552AC	NO			

△ 59354-□□□□□ LF

<PACKING METHOD>

R : TAPE REEL
DEFAULT : TRAY

<HOLD DOWN FINISH>

S : Pure Sn
B : Sn-Pb

<CONTACT AREA FINISH>

F : Au FLASH
T : Au 0.3μm MIN.
A : Au 0.76μm MIN.

<TOTAL HEIGHT>

52 : 5.2mm

<LOCATING PEG, SOLDER TAIL FINISH>

0 : YES, Au FLASH
1 : NO, Au FLASH
2 : YES, Pure Sn PLATING
3 : NO, Pure Sn PLATING
4 : YES, Sn-Pb PLATING
5 : NO, Sn-Pb PLATING

For Rohs OPTIONS:
TAIL PLATING CODE MUST BE 0~3.
HOLD DOWN PLATING CODE MUST BE "S".
"LF" CODE IS EXIST IN THE END.
EX: 59354-252TSLF

FOR NOT Rohs COMPATIBLE:
THIS "LF" CODE IS "BLANK".
EX:59354-452TS

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	FCI			
ltr	ecn no	dr	date	linear	.X ± 0.30 .XX ± 0.30		www.fciconnect.com			
L				linear		projection	title DDR SO-DIMM 0.6 mm PITCH 200 POS. STANDARD TYPE ASS'Y			
				angles	0° ±2°					
				dr	M.Hasegawa 4/6/04	MM	product family 50UF SO-DIMM			
				enr	M.Hasegawa 4/6/04	scale				
				chr		2:1	size dwg no B 59354			
				appd						
sheet index	revision sheet									